

TRANSMITTAL

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Title of Invention	[LOW-TEMPERATURE POLYSILICON THIN FILM TRANSISTOR AND FABRICATION METHOD THEREOF]							
Application Number :								
Date :								
First Named Applicant:	Mr. Cheng Chang Kuo							
Confirmation Number:								
Attorney Docket Number:	13137-US-PA							
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<table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td><td>Sign. Capacity</td></tr><tr><td>Dr. Belinda Lee Registered Number: 46,863</td><td>/Belinda Lee/</td><td>Agent</td></tr></table>			Submitted By:	Elec. Sign.	Sign. Capacity	Dr. Belinda Lee Registered Number: 46,863	/Belinda Lee/	Agent
Submitted By:	Elec. Sign.	Sign. Capacity						
Dr. Belinda Lee Registered Number: 46,863	/Belinda Lee/	Agent						

Documents being submitted:	Files
us-assignment	13137-usassn.xml us-assignment.xsl us-assignment.dtd 13137assignment01.tif 13137assignment02.tif
us-request	13137-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	13137-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	13137-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd 13137us0001.tif 13137us0002.tif 13137us0003.tif 13137us0004.tif 13137us0005.tif 13137us0006.tif 13137us0007.tif 13137us0008.tif 13137us0009.tif 13137us0010.tif

	13137us0011.tif
us-declaration	13137declaration1.tif
us-declaration	13137declaration2.tif
Comments	
<p>Please be kindly advised that the indicated fees of this EFS application is intended to be paid by credit card. However, in the event that the payment through credit card is unsuccessful, the Commissioner is authorized to charge the required fees in connection with this application to: Deposit Account No. 50-2620 (Order No.13137-US-PA), Deposit Account Name: Jianq Chyun Intellectual Property Office, Authorized User Name: Belinda Lee, E-mail: belinda@jcipgroup.com.tw; usa@jcipgroup.com.tw</p>	